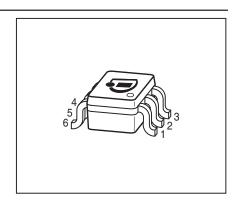


NPN Silicon RF Transistor

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- BFS17S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре | Marking | Pin Configuration | | | | | | Package |
|--------|---------|-------------------|------|------|------|------|------|---------|
| BFS17S | MCs | 1=B1 | 2=E1 | 3=C2 | 4=B2 | 5=E2 | 6=C1 | SOT363 |

Maximum Ratings at T_A = 25 °C, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|---------------------------------------|--------------------|---------|------|
| Collector-emitter voltage | V_{CEO} | 15 | V |
| Collector-base voltage | V_{CBO} | 25 | |
| Emitter-base voltage | V_{EBO} | 2.5 | |
| Collector current | I _C | 25 | mA |
| Peak collector current, f = 10 MHz | / _{CM} | 50 | |
| Total power dissipation ¹⁾ | P _{tot} | 280 | mW |
| <i>T</i> _S ≤ 93 °C | | | |
| Junction temperature | T_{J} | 150 | °C |
| Ambient temperature | T _A | -65 150 | |
| Storage temperature | T_{Stq} | -65 150 | |

Thermal Resistance

| Parameter | Symbol | Value | Unit |
|--|-------------------|-------|------|
| Junction - soldering point ²⁾ | R _{thJS} | ≤ 240 | K/W |

 $^{{}^{1}}T_{\mathrm{S}}$ is measured on the collector lead at the soldering point to the pcb

 $^{^2}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at T_A = 25°C, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|---|----------------------|--------|------|------|------|
| | | min. | typ. | max. | |
| DC Characteristics | · | | • | • | - |
| Collector-emitter breakdown voltage | V _{(BR)CEO} | 15 | - | - | V |
| $I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0 | , , | | | | |
| Collector-base cutoff current | I _{CBO} | | | | μA |
| $V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$ | | - | - | 0.05 | |
| $V_{\rm CB} = 25 \rm V, \it I_{\rm E} = 0$ | | - | - | 10 | |
| Emitter-base cutoff current | / _{EBO} | - | - | 100 | |
| $V_{\rm EB} = 2.5 \rm V, I_{\rm C} = 0$ | | | | | |
| DC current gain | h _{FE} | | | | - |
| $I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 1 V, pulse measured | | 40 | - | 150 | |
| $I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 1 V, pulse measured | | 20 | 70 | | |
| Collector-emitter saturation voltage | V _{CEsat} | - | 0.1 | 0.4 | V |
| $I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA | | | | | |



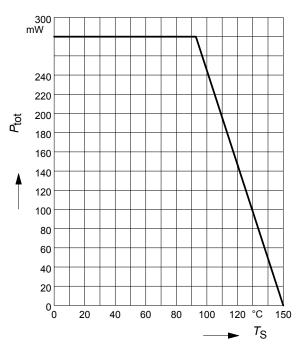
Electrical Characteristics at T_A = 25°C, unless otherwise specified

| Symbol | Values | | | Unit | | |
|--|--|-------------|---|--|--|--|
| | min. | typ. | max. | | | |
| AC Characteristics (verified by random sampling) | | | | | | |
| f_{T} | | | | GHz | | |
| | 1 | 1.4 | - | | | |
| | 1.3 | 2.5 | - | | | |
| C _{cb} | - | 0.55 | 0.8 | pF | | |
| | | | | | | |
| | | | | | | |
| C _{ce} | - | 0.2 | - | | | |
| | | | | | | |
| | | | | | | |
| C _{eb} | - | 0.9 | 1.45 | | | |
| | | | | | | |
| | | | | | | |
| NF _{min} | - | 3 | 5 | dB | | |
| | | | | | | |
| | | | | | | |
| $ S_{21e} ^2$ | - | 14 | - | dB | | |
| | | | | | | |
| | | | | | | |
| IP ₃ | - | 22.5 | - | dBm | | |
| | | | | | | |
| | | | | | | |
| P _{-1dB} | - | 11 | - | - | | |
| | | | | | | |
| | | | | | | |
| | Symbol g) fT C _{cb} C _{ce} NF _{min} S _{21e} ² | min. g) fT | Symbol Values min. typ. f_T 1 1.4 1.3 2.5 0.55 C_{cb} - 0.2 NF_{min} - 3 $ S_{21e} ^2$ - 14 $ P_3$ - 22.5 | Symbol min. typ. max. g) f_T 1 1.4 - 1.3 2.5 - 1.3 2.5 1.4 1.3 1.3 1.4 1.4 1.3 1.3 1.4 1.4 1.3 1.3 1.4 1.4 1.3 1.3 1.4 1.4 1.4 1.3 1.3 1.4 1.4 1.4 1.4 1.4 1.4 1.4 1.4 1.4 1.4 | | |



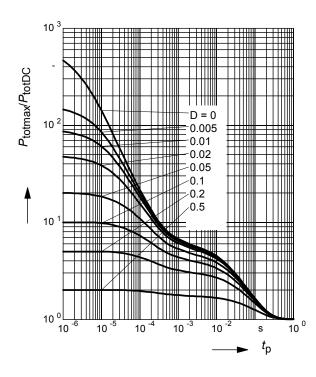
Total power dissipation $P_{tot} = f(T_S)$

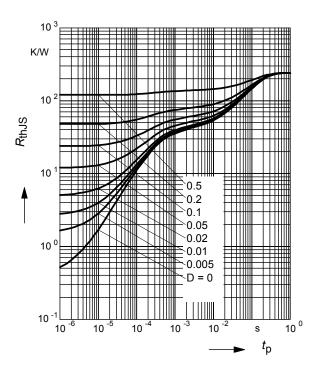
Permissible Pulse Load $R_{thJS} = f(t_p)$



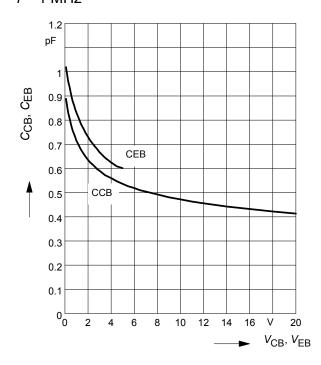
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$





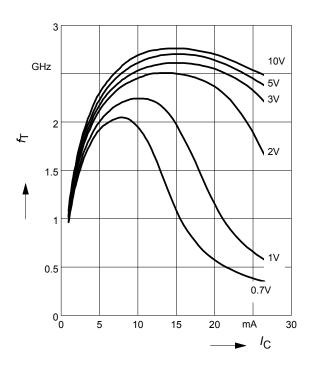
Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$ f = 1 MHz





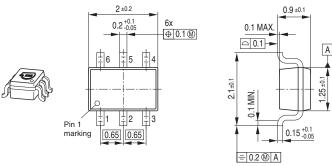
Transition frequency $f_T = f(I_C)$

 V_{CE} = parameter

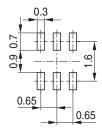




Package Outline

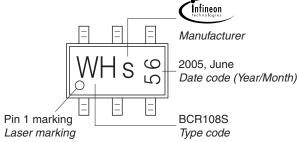


Foot Print



Marking Layout (Example)

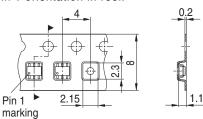
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



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